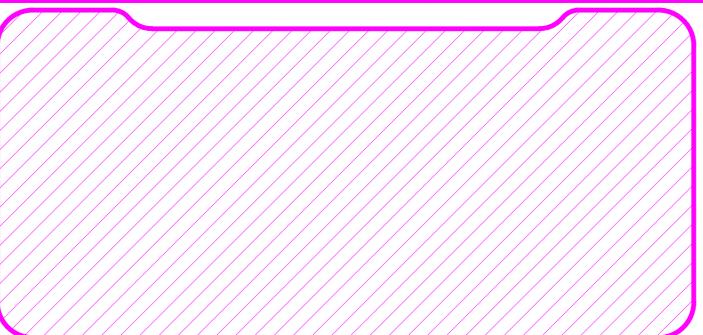
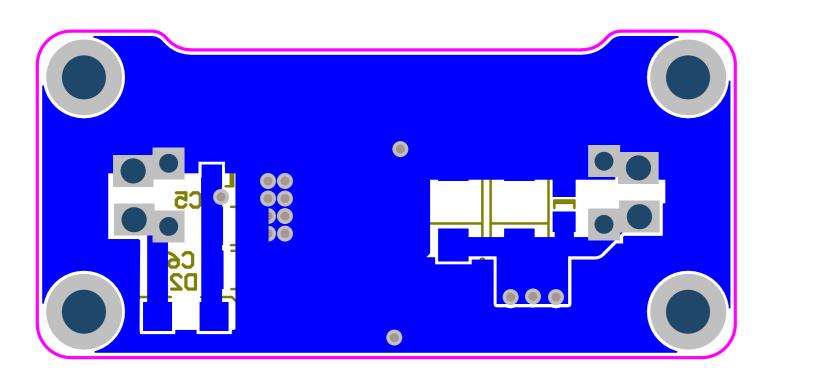


Layer	Name	Material	Thickness	Constant	Board Layer Stack			
1	Top Overlay							
2	Top Solder	Solder Resist	0.40mil	3.5				
3	Top Layer	Copper	1.40mil					
4	Dielectric1	FR-4	12.60mil	4.8				
5	Bottom Layer	Copper	1.40mil					
6	Bottom Solder	Solder Resist	0.40mil	3.5				
7	Bottom Overlay							





Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	Top Overlay				
2	Top Solder	Solder Resist	O.40mil	3.5	
3	Top Layer	Copper	1.40mil		
4	Dielectric1	FR-4	12.60mil	4.8	
5	Bottom Layer	Copper	1.40mil		
6	Bottom Solder	Solder Resist	O.40mil	3.5	
7	Bottom Overlay				





